

## Contents

1	Introduction.....	2
2	Basic Access to OTP Data.....	2
2.1.1.	Read Procedure.....	2
2.1.2.	Write Procedure.....	2
2.1.3.	Simple Tests.....	3
3	Configuration Programming.....	3
3.1.	Format of the ROM File.....	3
4	External Temperature Calibration.....	4
4.1.	Requirements.....	4
4.2.	Calibration Procedure.....	4
4.3.	Correction Procedure for Ambient Temperatures Other than 25°C.....	5
4.4.	Calculation Examples for Ambient Temperatures Other than 25°C.....	5
4.5.	Additional Information for Temperature Calibration.....	5
5	Current Calibration Procedure.....	6
5.1.	Requirements.....	6
5.2.	Calibration Procedure.....	6
5.3.	Computation of Current Sense Correction Factors.....	7
5.4.	DCR Temperature Correction during Calibration.....	7
5.5.	Calculation Examples.....	8
6	PMBus™ Command Reference.....	10
6.1.	Overview about PMBus™ Commands.....	10
6.2.	PMBus™ Command Definitions.....	10
6.2.1.	READ_IOUT.....	10
6.2.2.	READ_TEMPERATURE_1.....	10
6.2.3.	READ_TEMPERATURE_2.....	10
6.2.4.	MFR_ADDRESS_POINTER.....	11
6.2.5.	MFR_OTP_READ_DATA.....	11
6.2.6.	MFR_OTP_WRITE_DATA.....	11
6.2.7.	MFR_OTP_STATUS.....	11
6.2.8.	MFR_REVISION.....	11
7	Related Documents.....	12
8	Document Revision History.....	12

## 1 Introduction

The ZSPM10X5A (ZSPM1025A/ZSPM1035A) is delivered without configuration or calibration, so the devices must be programmed prior to the first use. This is typically done using a programming fixture prior to soldering the components on the circuit board or during the end-of-line testing and calibration steps. Note that the devices will not power up their output voltage or react to the OPERATION command until the configuration has been written. This prevents any damage to the application caused by invalid configuration parameters.

The configuration is stored in a one-time-programmable memory (OTP) integrated in the ZSPM10x5A. Note that the ZSPM10x5A is only programmable once. Two different sets of parameters must be programmed: one for configuration and another for calibration. Configuration parameters are constant over all devices for a given application and can be programmed at any time during production. This includes parameters such as switching frequency and compensation.

Calibration data is specific to the ZSPM10X5A/board and must be programmed for each individual unit. It includes coefficients such as current sense offset, gain correction factors, and temperature offset correction. This application note details the end-of-line calibration functions of the ZSPM10x5A. The ZSPM10x5A supports calibration of the external temperature sense element and the current sense circuitry.

Refer to section 6 and also to the data sheet for the ZSPM1025 or ZSPM1035A regarding PMBus™ commands referenced in this document. Refer to the *Pink Power Designer™ Graphic User Interface (GUI)* if using the Pink Power Designer™ Graphical User Interface (GUI) to expedite configuration and calibration of the ZSPM10x5A.

## 2 Basic Access to OTP Data

As with the configuration data, calibration data is stored in the OTP of the ZSPM10x5A. Two basic subroutines allow access to the OTP.

### 2.1.1. Read Procedure

OTP data can be read from the device at any time during operation using the following steps:

- 1.) Set the OTP address pointer using the MFR\_ADDRESS\_POINTER command.
- 2.) Read the data using an MFR\_OTP\_READ\_DATA command.

### 2.1.2. Write Procedure

OTP data can be written into the device using the following steps:

- 1.) Clear the OTP status register by writing 00000104<sub>HEX</sub> using the MFR\_OTP\_STATUS command.
- 2.) Set the OTP address pointer using the MFR\_ADDRESS\_POINTER command.
- 3.) Write OTP data using the MFR\_OTP\_WRITE\_DATA command.
- 4.) Finally check the OTP status to determine if the programming has been successful; i.e., read MFR\_OTP\_STATUS and check if bit 2 is zero.

Steps 2 and 3 can be repeated in a loop in order to write more than one data word. The status information is then accumulated over all write operations. Interrupting read operations, e.g. to verify the data, will not clear the status information.

### 2.1.3. Simple Tests

The OTP procedure can be tested using OTP cell E4D<sub>HEX</sub>. Unconfigured parts should return 0004<sub>HEX</sub>.

The OTP programming procedure can be tested using OTP spare cells at the end of the OTP configuration table. Table 2.1 provides the addresses.

**Table 2.1 OTP Spare Cells per Device**

Device Name	Address Range for Spare Cells
ZSPM10x5A	EF8 <sub>HEX</sub> to EFE <sub>HEX</sub>

## 3 Configuration Programming

Programming the configuration is the first step in production, prior to running any calibration routines. The Pink Power Designer™ GUI can be used to generate the configuration and store it in a ROM file. This is a plain text file that contains address and data values as detailed below. The contents of this ROM file can be downloaded into the part using the OTP write procedures detailed above or by using the Power Designer™ GUI.

Note that the configuration data is activated in the device only after a power cycle.

The configuration table's address range is given in Table 3.1. Recommendation: program the OTP starting from the highest address.

**Table 3.1 OTP Configuration Table per Device**

Device Name	Address Range for Configuration
ZSPM10x5A	E4D <sub>HEX</sub> to EF7 <sub>HEX</sub>

The comment header of the ROM file contains information about the part for which it has been created.

Recommendation: Compare the firmware (FW) version of the part to the FW version information stored in the ROM file to ensure proper operation. The FW version can be read using the MFR\_REVISION command (see sections 6.1 and 6.2.8).

### 3.1. Format of the ROM File

The configuration of the device is available in a ROM file format and can be used to program the device in production. The file format of this ROM file is defined as follows:

Comment lines start with // and should be ignored.

Data lines are defined as

@[OTP ADDRESS] \_ \_ [OTP DATA]

where OTP\_ADDRESS represents the address of the OTP cell and OTP\_DATA its contents. Both values are stored as a 16-bit word in hexadecimal format and must be separated by two spaces in the ROM file.

Example of an excerpt from a ROM file:

```
//  
// Firmware version: "1.1.1" [MFR_REVISION=0x31313131]  
//  
@0E4D_0027  
@0E4E_0018  
@0E4D_0007  
@0E4E_0018  
@0E4F_2662  
@0E50_0000
```

## 4 External Temperature Calibration

External temperature sensors vary in forward voltage, which requires a calibration of the 25°C reference voltage.

### 4.1. Requirements

- The device must be configured using OTP.
- The external sense element must be connected to the ZSPM10x5A.
- The actual ambient temperature must be known.
- The device must not have been temperature calibrated before; i.e., the OTP cell EED<sub>HEX</sub> is empty.

### 4.2. Calibration Procedure

The actual calibration procedure is simple.

- 1.) Read the actual measurement value from the device using the READ\_TEMPERATURE\_1 command.
- 2.) Optional: Apply a correction procedure in case the ambient temperature is not 25°C (see section 4.3).
- 3.) Write the temperature offset value into OTP cell EED<sub>HEX</sub> using the OTP data write procedure.
- 4.) Optional: Verify the procedure by reading via the READ\_TEMPERATURE\_1 command. This should now return the ambient temperature in degrees Celsius.

### 4.3. Correction Procedure for Ambient Temperatures Other than 25°C

The temperature sense offset value required by the device is designed for 25°C; therefore, if calibration is run at a different ambient temperature, the offset value read during step 1 of the calibration procedure must to be corrected prior to step 3 above.

This can be done by applying the following equation:

$$\text{EXT\_TEMP\_REF\_COR} = \text{EXT\_TEMP\_REF} + (\text{TEMP\_AMBIENT} - 25) / \text{EXT\_TEMP\_SENSE}$$

Where

EXT\_TEMP\_REF\_COR is the corrected offset.

EXT\_TEMP\_REF is the offset value read from the device at the ambient temperature.

TEMP\_AMBIENT is the ambient temperature value.

EXT\_TEMP\_SENSE is the sensitivity of the external temperature sensor as read from the device.

EXT\_TEMP\_SENSE can be calculated from the content of OTP cell EEE<sub>HEX</sub> using the following equation:

$$\text{EXT\_TEMP\_SENSE} = (65536 - \text{OTP}[\text{EEE}_{\text{HEX}}]) / 2048.$$

### 4.4. Calculation Examples for Ambient Temperatures Other than 25°C

Setup 1: Ambient temperature correction is used.

Assume that the ambient temperature is 40°C; READ\_TEMPERATURE\_1 returns a value of 849<sub>DEC</sub>; and the OTP cell EEE<sub>HEX</sub> contains a value of FD71<sub>HEX</sub>.

Calculate the corrected temperature offset:

$$\text{EXT\_TEMP\_REF\_COR} = 849 + (40 - 25) / ((65536 - 64881)/2048) = 895 = 037\text{F}_{\text{HEX}}$$

Write the results 037F<sub>HEX</sub> into OTP cell EED<sub>HEX</sub>.

Now use READ\_TEMPERATURE\_1 to verify the calibration. If the procedure was the successful, the result of the read will be 40°C, which is the temperature used for calibration.

Setup 2: Ambient temperature correction is NOT used.

Assume that the ambient temperature is 40°C and READ\_TEMPERATURE\_1 returns a value of 849<sub>DEC</sub>.

As the ambient temperature connection is not used, write 849<sub>DEC</sub> into OTP cell EEE<sub>HEX</sub>.

Verifying the results via READ\_TEMPERATURE\_1 returns a value of 25°C even though the actual temperature is 40°C. This is expected as the part has been set up to accept the value of 40°C as its 25°C reference.

### 4.5. Additional Information for Temperature Calibration

Note that the absolute value of the temperature is only important for the monitoring the temperature. Temperature correction of the DCR could run from any temperature code, as long the current calibration procedure has been performed for the same temperature.

If the ambient temperature is unknown, the internal temperature sensor can be used as a reference for calibration.

## 5 Current Calibration Procedure

In order to improve the accuracy of the current sense circuitry of the device, a two-point current calibration procedure is recommended. This will calibrate the offset and gain error of the current sense circuitry and improve performance considerably.

### 5.1. Requirements

- The device must be configured using OTP.
- The external temperature sense element must have been calibrated if DCR temperature compensation is used with the external temperature sensor.
- The device has not been current calibrated before; i.e., OTP cells E52<sub>HEX</sub> and E53<sub>HEX</sub> are empty.
- The user must be able to draw two known currents from the power converter; e.g., an electronic load has been connected to the output voltage.

### 5.2. Calibration Procedure

- 1.) The over-current protection of the device must be disabled so that the calibration currents do not trigger an over-current event. This is done by sending the following PMBus™ command sequence:

**Table 5.1 Command Sequence for Disabling Over-Current Protection**

CMD Code	Data Bytes (lowest byte first)	Transaction Type
F9 <sub>HEX</sub>	01 <sub>HEX</sub> , 00 <sub>HEX</sub>	Write word
F8 <sub>HEX</sub>	80 <sub>HEX</sub> , 3E <sub>HEX</sub>	Write word
FA <sub>HEX</sub>	00 <sub>HEX</sub> , 00 <sub>HEX</sub>	Write word

- 2.) Apply a known load current  $I_{OUT1}$ .
- 3.) Measure the output current reported from the device using the READ\_IOUT command ( $I_{OUT1\_MEAS}$  in section 5.3).  
Optional: Measure the temperature for  $I_{OUT1}$  using the READ\_TEMPERATURE\_x command.
- 4.) Apply a known load current  $I_{OUT2}$ .
- 5.) Measure the output current reported from the device using the READ\_IOUT command ( $I_{OUT2\_MEAS}$  in section 5.3).  
Optional: Measure the temperature for  $I_{OUT2}$  using the READ\_TEMPERATURE\_x command.
- 6.) Optional: Enable the over-current protection again.

**Table 5.2 Command Sequence for Re-enabling Over-Current Protection**

CMD Code	Data Bytes (lowest byte first)	Transaction Type
F9 <sub>HEX</sub>	01 <sub>HEX</sub> , 00 <sub>HEX</sub>	Write word
F8 <sub>HEX</sub>	80 <sub>HEX</sub> , 3e <sub>HEX</sub>	Write word
FA <sub>HEX</sub>	80 <sub>HEX</sub> , 00 <sub>HEX</sub>	Write word

- 7.) Compute the gain and offset correction factors according to the equations listed in the next section.
- 8.) Write gain and offset correction factors in the ZSPM10x5A. The gain factor is written into OTP cell E52<sub>HEX</sub>; the offset value is written into OTP cell E53<sub>HEX</sub>.

### 5.3. Computation of Current Sense Correction Factors

The gain and offset correction factors can be computed from the nominal and measured current values using the following equations:

$$\text{Gain correction factor: } I_{\text{OUT\_CAL\_GAIN\_CORR}} = (I_{\text{OUT2}} - I_{\text{OUT1}}) / (I_{\text{OUT2\_MEAS}} - I_{\text{OUT1\_MEAS}})$$

$$\text{Offset correction factor: } I_{\text{OUT\_CAL\_OFFSET}} = I_{\text{OUT1}} - (I_{\text{OUT1\_MEAS}} * I_{\text{COUT\_CAL\_GAIN\_CORR}})$$

Both values must be scaled prior to writing them into their respective OTP cells:

$$I_{\text{OUT\_CAL\_GAIN\_CORR\_OTP}} = I_{\text{OUT\_CAL\_GAIN\_CORR}} * 128$$

$$I_{\text{OUT\_CAL\_OFFSET\_OTP}} = I_{\text{OUT\_CAL\_OFFSET}} * I_{\text{OUT\_READ\_FACTOR}}$$

I<sub>OUT\_READ\_FACTOR</sub> can be calculated from the content of OTP cell EF1<sub>HEX</sub> using the following equation:

$$I_{\text{OUT\_READ\_FACTOR}} = \text{OTP}[EF1_{\text{HEX}}] / 32.$$

Prior to writing the values into the OTP, the calibration values should be checked for correctness, as the values are constrained by the following limits:

**Table 5.3 Limits for Calibration Values**

Value	Data Format	Lower Limit	Upper Limit
I <sub>OUT_CAL_GAIN_CORR_OTP</sub>	Unsigned Q1.7	0.5 (0040 <sub>HEX</sub> )	1.5 (00C0 <sub>HEX</sub> )
I <sub>OUT_CAL_OFFSET_OTP</sub>	Signed Q0.7, 16-bit signed extended	-0.75 (FFA0 <sub>HEX</sub> )	0.75 (0060 <sub>HEX</sub> )

### 5.4. DCR Temperature Correction during Calibration

If output current sensing is required with high accuracy or the temperature during calibration is significantly higher than 25°C, a correction of the DCR temperature rise is recommended during calibration. This is due to the fact that gain and offset of the current sense circuitry are defined for 25°C.

This temperature correction can be easily done by scaling the measured currents with the DCR temperature correction values.

The current information read with the READ\_IOUT command is converted into the temperature-corrected current IOUT\_TC\_COR using

$$IOUT\_TC\_COR = READ\_IOUT / (1.0 + TC\_DCR * (T - 25))$$

Where

TC\_DCR is the temperature coefficient of the DCR.

T is the actual temperature during the measurement of the output current.

The temperature corrected currents are then substituted into the equations in section 5.3 instead of the actual uncorrected readings.

Recommendation: Read the temperature of the sensor configured for the DCR temperature correction algorithm in the device; i.e., READ\_TEMPERATURE\_1 if the external sensor is used and READ\_TEMPERATURE\_2 if the internal sensor is used.

The temperature coefficient of the DCR is set to 3900ppm/°C by default. Alternatively, it can be extracted from the device using the following equations:

If the external temperature sensor is used:  $TC\_DCR = OTP[EF2_{HEX}] / 16.0 / OTP[EEE_{HEX}]$

If the internal temperature sensor is used:  $TC\_DCR = OTP[EF2_{HEX}] / 16.0 / OTP[E47_{HEX}]$

Note that the OTP cells EF2<sub>HEX</sub>, EEE<sub>HEX</sub> and E47<sub>HEX</sub> are all in 16-bit signed data format.

## 5.5. Calculation Examples

Scenario 1:

Assume this is a calibration of a power converter with a nominal current of I<sub>OUT1</sub> = 5.0A and I<sub>OUT2</sub> = 25A; the OTP[EF1<sub>HEX</sub>] = 19B<sub>HEX</sub>; and I<sub>OUT1\_MEAS</sub> has been measured as 2.8A and I<sub>OUT2\_MEAS</sub> as 19.7A.

Calculate the correction coefficients:

$$IOUT\_CAL\_GAIN\_CORR = (25.0 - 5.0) / (19.7 - 2.8) = 1.18$$

$$IOUT\_CAL\_OFFSET = 5 - (2.8 * 1.18) = 1.70.$$

Convert this into OTP format as follows:

$$IOUT\_CAL\_GAIN\_CORR\_OTP = 1.18 * 128 = 151 = 0097_{HEX}$$

$$IOUT\_CAL\_OFFSET\_OTP = 1.70 * (411 / 32) = 22 = 0016_{HEX}$$

Both values lie within the allowed limits of the ZSPM10x5A and hence can be written into the IC.

Scenario 2:

Assume this is a calibration of a power converter with nominal current of I<sub>OUT1</sub> = 5.0A and I<sub>OUT2</sub> = 15A; the OTP[EF1<sub>HEX</sub>] = 19B<sub>HEX</sub>; and I<sub>OUT1\_MEAS</sub> has been measured as 4.79 A and I<sub>OUT2\_MEAS</sub> as 13.66 A.

Calculate the correction coefficients:

$$IOUT\_CAL\_GAIN\_CORR = (15.0 - 5.0) / (13.66 - 4.79) = 1.128$$

$$IOUT\_CAL\_OFFSET = 5 - (4.79 * 1.128) = -0.402.$$



Convert this into OTP format as follows:

$$IOUT\_CAL\_GAIN\_CORR\_OTP = 1.128 * 128 = 144 = 0090_{HEX}$$

$$IOUT\_CAL\_OFFSET\_OTP = -0.402 * (411 / 32) = -5 = FFFB_{HEX}$$

Both values lie within the allowed limits of the ZSPM10x5A and hence can be written into the IC.

Scenario 3:

Assume this is a calibration of a power converter with nominal current of  $I_{OUT1} = 5.0A$  and  $I_{OUT2} = 20A$ ;  $I_{OUT1\_MEAS}$  has been measured as 4.96 A at 31.0°C and  $I_{OUT2\_MEAS}$  as 18.24 A at 31.0°C. The OTP contains these values:  $OTP[EEE_{HEX}] = FD70_{HEX}$ ,  $OTP[EF1_{HEX}] = 019B_{HEX}$  and  $OTP[EF2_{HEX}] = FFD2_{HEX}$ . The external temperature sensor is used for DCR compensation.

The DCR temperature coefficients is calculated as

$$TC\_DCR = -41 / 16.0 / -655 = 0.0039$$

Next the current measurements are temperature corrected:

$$IOUT1\_TC\_COR = 4.96 / (1.0 + 0.0039 * (31.0 - 25.0)) = 4.84$$

$$IOUT1\_TC\_COR = 18.24 / (1.0 + 0.0039 * (31.0 - 25.0)) = 17.82$$

Substituting these values into the equations gives

$$IOUT\_CAL\_GAIN\_CORR = (20.0 - 5.0) / (17.82 - 4.84) = 1.156$$

$$IOUT\_CAL\_OFFSET = 5 - (4.84 * 1.156) = -0.600.$$

Convert this into OTP format as follows:

$$IOUT\_CAL\_GAIN\_CORR\_OTP = 1.156 * 128 = 148 = 0094_{HEX}$$

$$IOUT\_CAL\_OFFSET\_OTP = -0.600 * (411 / 32) = -8 = FFF8_{HEX}$$

Both values lie within the allowed limits of the ZSPM10x5A and hence can be written into the IC.

## 6 PMBus™ Command Reference

### 6.1. Overview about PMBus™ Commands

**Table 6.1 PMBus™ Command Overview**

PMBus™ Command	Description	Transaction Type	Command Byte (hex)	Data Length (bytes)
READ_IOUT	Output current	Read word	8C <sub>HEX</sub>	2
READ_TEMPERATURE_1	External temperature	Read word	8D <sub>HEX</sub>	2
READ_TEMPERATURE_2	Internal temperature	Read word	8E <sub>HEX</sub>	2
MFR_REVISION	Device FW revision <sup>1.)</sup>	Block read	9D <sub>HEX</sub>	(4)
MFR_ADDRESS_POINTER	Address pointer for OTP operation	Read word Write word	F8 <sub>HEX</sub>	2
MFR_OTP_READ_DATA	Read data from OTP	Read word	F1 <sub>HEX</sub>	2
MFR_OTP_WRITE_DATA	Write data to OTP	Write Word	F0 <sub>HEX</sub>	2
MFR_OTP_STATUS	OTP status information	Read word Write word	EF <sub>HEX</sub>	4

1.) This is a block command; i.e., the length of the data is transmitted as the first byte of the message.

### 6.2. PMBus™ Command Definitions

#### 6.2.1. READ\_IOUT

READ_IOUT (read only)		
Bits	Name	Description
[15:0]	IOUT	Output current in A (linear data format).

#### 6.2.2. READ\_TEMPERATURE\_1

READ_TEMPERATURE_1 (read only)		
Bits	Name	Description
[15:0]	TEMP1	External temperature in °C (linear data format). RAW data format if device is not temperature calibrated.

#### 6.2.3. READ\_TEMPERATURE\_2

READ_TEMPERATURE_2 (read only)		
Bits	Name	Description
[15:0]	TEMP2	Internal temperature in °C (linear data format).

#### 6.2.4. MFR\_ADDRESS\_POINTER

MFR_ADDRESS_POINTER (read / write)		
Bits	Name	Description
[0]	RESERVED	
[15:1]	ADDRESS	Address of OTP data access

#### 6.2.5. MFR\_OTP\_READ\_DATA

READ_OTP_READ_DATA (read only)		
Bits	Name	Description
[15:0]	DATA	Data read from OTP at the address set by MFR_ADDRESS_POINTER

#### 6.2.6. MFR\_OTP\_WRITE\_DATA

MFR_OTP_WRITE_DATA (write only)		
Bits	Name	Description
[15:0]	DATA	Data to be written into OTP at address set by MFR_ADDRESS_POINTER

#### 6.2.7. MFR\_OTP\_STATUS

MFR_OTP_STATUS (read / write)		
Bits	Name	Description
[1:0]	Reserved	
[2]	FAILED	OTP Programming has failed. Write a one to clear this bit.
[7:3]	Reserved	
[8]	CLEAR	Clear OTP faults by writing 1 to this bit.
[31:9]	Reserved	

#### 6.2.8. MFR\_REVISION

MFR_REVISION (read)		
Bits	Name	Description
[31:0]	REVISION	FW Revision in ISO/IEC 8859-1 format.

## 7 Related Documents

Document
<i>ZSPM1025A Data Sheet</i>
<i>ZSPM1035A Data Sheet</i>
<i>ZSPM8025-KIT Evaluation Kit Description</i>
<i>ZSPM8035-KIT Evaluation Kit Description</i>
<i>Pink Power Designer™ Graphic User Interface (GUI)</i>

Visit [www.IDT.com/ZSPM1025A](http://www.IDT.com/ZSPM1025A), [www.IDT.com/ZSPM1035A](http://www.IDT.com/ZSPM1035A), [www.IDT.com/ZSPM8025-KIT](http://www.IDT.com/ZSPM8025-KIT), [www.IDT.com/ZSPM8035-KIT](http://www.IDT.com/ZSPM8035-KIT) or contact your nearest sales office for the latest version of these documents.

## 8 Document Revision History

Revision	Date	Description
1.00	October 22, 2013	First release.
	April 7, 2016	Changed to IDT branding.

## IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES (“RENESAS”) PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES “AS IS” AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD-PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers who are designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only to develop an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third-party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising from your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Disclaimer Rev.1.01 Jan 2024)

### Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

### Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

### Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit [www.renesas.com/contact-us/](http://www.renesas.com/contact-us/).